BMEP581020

processor module M580 - Level 1 - Distributed





Main

Range of product	Modicon M580
Product or component type	Processor module
Supply	Internal power supply via rack

Complementary

Number of racks	4	
Discrete I/O processor capacity	1024 I/O	
Analogue I/O processor capacity	256 I/O	
Number of application specific channel	36	
Application specific I/O	Accurate time stamping Counter Serial link Motion control HART SSI encoder	
Checks	Process control	
Control channels	Programmable loops	
Integrated connection type	USB type mini B 1 Ethernet TCP/IP service port 2 Ethernet TCP/IP device network	
Number of distributed equipment	64	
Communication module processor capacity	2 Ethernet communication module 8 AS-Interface module	
Communication service	DIO scanner	
Memory description	Integrated RAM 4 MB program Integrated RAM 384 kB data Expandable flash 4 GB data storage Integrated RAM 10 kB system memory	
Application structure	1 cyclic/periodic master task 1 periodic fast task 64 event tasks 2 auxiliary tasks	
Number of instructions per ms	7.5 Kinst/ms 65 % Boolean + 35 % fixed arithmetic 10 Kinst/ms 100 % Boolean	
Current consumption	270 mA 24 V DC	
MTBF reliability	600000 H	
Marking	CE	
Status LED	1 LED green processor running (RUN) 1 LED red I/O module fault (I/O) 1 LED red processor or system fault (ERR) 1 LED green download in progress (DL) 1 LED red memory card or CPU flash fault (BACKUP) 1 LED green/red ETH MS (Ethernet port configuration status) 1 LED green/red Eth NS (Ethernet network status)	
Product weight	0.849 kg	

Environment

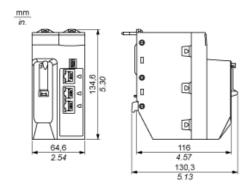


vibration resistance	3 gn
shock resistance	30 gn
ambient air temperature for operation	060 °C
ambient air temperature for storage	-4085 °C
operating altitude	02000 m 20005000 m (with derating factor)
relative humidity	595 % 55 °C conforming to without condensation
IP degree of protection	IP20
standards	EN/IEC 61131-2 EN/IEC 61010-2-201 CSA C22.2 No 61010-2-201
product certifications	CE CSA UL RCM Merchant Navy EAC

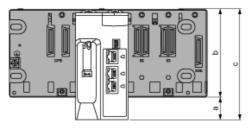
Offer Sustainability

Sustainable offer status	Green Premium product
RoHS (date code: YYWW)	Compliant - since 1623 - Schneider Electric declaration of conformity
REACh	Reference not containing SVHC above the threshold
Product environmental profile	Available
Product end of life instructions	Available

CPU MODULE ONLY



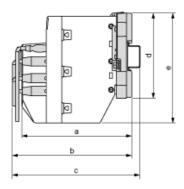
Modules Mounted on Racks



- a: additional space below the rack to accommodate the height of the CPU. For an X Bus rack, the value is 30.9 mm (1.217 in.); for an Ethernet rack, the value is 29.49 mm (1.161 in.).
- b: the height of the rack. For an X Bus rack, the height is 103.7 mm (4.083 in.); for an Ethernet rack, the height is 105.11 mm (4.138 in.).
- c: the height of the main local rack, 134.6 mm (5.299 in.)

Modules and Cables Mounted in an Enclosure





- a: enclosure depth: 135 mm (5.315 in.)
- **b:** wiring + module depth: > 146 mm (5.748 in.)
- c: wiring + module + DIN rail depth: > 156 mm (6.142 in.)
- d: rack height: for an X Bus rack 103.7 mm (4.083 in.); for an Ethernet rack, 105.11 mm (4.138 in.)
- e: module height: 134.6 mm (5.299 in.)